AUG 1 1 2003 BY AUG 1 20

In re application of

Confirmation No. 6849

Takeshi HASHIMOTO et al.

Docket No. 2001_1790

Serial No. 10/029,991

Group Art Unit 1712

Filed December 31, 2001

Examiner M. Zimmer

THERMOSETTING LOW-DIELECTRIC RESIN COMPOSITION AND USE THEREOF

THE COMMISSIONER IS AUTHORIZED TO CHARGE ANY DEFICIENCY IN THE FEES FOR THIS PAPER TO DEPOSIT ACCOUNT NO. 23-0975

RECEIVED
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PETITION FOR EXTENSION OF TIME

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

Petition hereby is made for a one month extension of time to respond to the communication of April 10, 2003.

The fee of \$110.00 is

- (X) submitted herewith.
- () to be charged to Deposit Account No. 23-0975. A duplicate copy of this Petition is enclosed.
- O Small entity status of this application is established by a Small Entity Status Assertion which
 - () is enclosed.
 - () has been previously submitted.

Respectfully submitted,

Takeshi HASHIMOTO et al.

08/12/2003 HDEMESS1 00000024 10029991

01 FC:1251

110.00 DP

By <u>Matthew</u> Jacob

Registration No.25,154 Attorney for Applicants

MJ/edg Washington, D.C. 20006-1021 Telephone (202) 721-8200 Facsimile (202) 721-8250 August 11, 2003